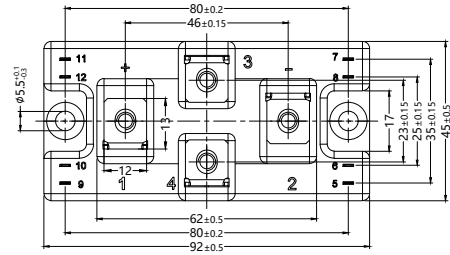
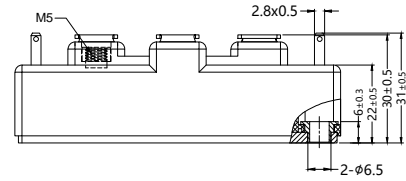


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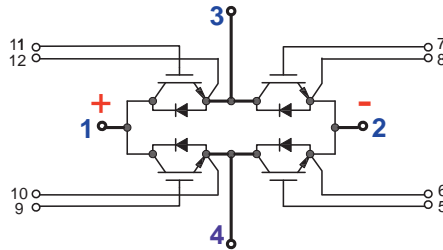
H bridge IGBT modules



Dimension: mm



$V_{CES} = 1200V$
 $I_{C100} = 4X40A$
 $V_{CESat(typ)} = 1.85V$
 $E_{off(typ)} = 1.4mJ$



Absolute Maximum Ratings

Symbol	Test Conditions	Values	Unit	
IGBT				
V_{CES}	$T_j = 25^\circ C$	1200	V	
I_C	$T_j = 175^\circ C$	$T_c = 25^\circ C$	80	A
		$T_c = 80^\circ C$	40	A
I_{Cnom}	$T_c = 100^\circ C$ Every chip	40	A	
I_{CRM}	$I_{CRM} = 3 \times I_{Cnom}$	120	A	
V_{GES}		-20 ... +20	V	
$tpsc$	$V_{CC} = 800 V$ $V_{GE} \leq 15 V$ $V_{CES} \leq 1200 V$	$T_j = 150^\circ C$ 10	μs	
T_j		-40 ... +175	$^\circ C$	
Inverse diode				
I_F	$T_j = 175^\circ C$	$T_c = 25^\circ C$	40	A
		$T_c = 80^\circ C$	20	A
I_{Fnom}		40	A	
I_{FRM}	$I_{FRM} = 3 \times I_{Fnom}$	120	A	
I_{FSM}	$tp = 10 ms, \sin 180^\circ, T_j = 25^\circ C$	90	A	
T_j		-40 ... +150	$^\circ C$	
Module				
$I_{t(RMS)}$	$T_{terminal} = 80^\circ C$	200	A	
T_{stg}		-40 ... 125	$^\circ C$	
V_{isol}	AC sinus 50 Hz, $t = 1 min$	4000	V	

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H bridge IGBT modules

Characteristics						
Symbol	Test Conditions	min.	typ.	max.	Unit	
IGBT						
$V_{CE(sat)}$	$I_C = 40A$ $V_{GE} = 15V$ chip level	$T_j = 25^\circ C$	1.85	2.10	V	
		$T_j = 150^\circ C$	2.10	2.30	V	
V_{CE0}	chiplevel	$T_j = 25^\circ C$	0.8	0.9	V	
		$T_j = 150^\circ C$	0.7	0.8	V	
r_{CE}	$V_{GE} = 15V$	$T_j = 25^\circ C$	14.00	16.00	m Ω	
	chiplevel	$T_j = 150^\circ C$	21.00	22.00	m Ω	
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 1.7 mA$		5	5.8	6.5	V
I_{CES}	$V_{GE} = 0V$	$T_j = 25^\circ C$		1	mA	
	$V_{CE} = 1200 V$	$T_j = 150^\circ C$			mA	
C_{ies}	$V_{CE} = 25V$	$f = 1MHz$	2.70		nF	
C_{oes}	$V_{GE} = 0V$	$f = 1 MHz$	0.17		nF	
C_{res}		$f = 1MHz$	0.09		nF	
Q_G	$V_{GE} = - 8 V \dots + 15 V$		270		nC	
R_{Gint}	$T_j = 25^\circ C$		4.0		Ω	
$t_{d(on)}$	$V_{CC} = 600 V$ $I_C = 40A$ $V_{GE} = \pm 15V$ $R_{G on} = 1\Omega$ $R_{G off} = 1\Omega$ $di/dt_{on} = 1700 A/\mu s$ $di/dt_{off} = 670A/\mu s$	$T_j = 150^\circ C$	55		ns	
t_r		$T_j = 150^\circ C$	39		ns	
E_{on}		$T_j = 150^\circ C$	3.3		mJ	
$t_{d(off)}$		$T_j = 150^\circ C$	265		ns	
t_f		$T_j = 150^\circ C$	30		ns	
E_{off}		$T_j = 150^\circ C$	1.4		mJ	
$R_{th(j-c)}$		per IGBT			0.58	K/W



Sirectifier®

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H bridge IGBT modules

Characteristics					
Symbol	Test Conditions	min.	typ.	max.	Unit
Inverse diode					
$V_F = V_{EC}$	$I_F = 20A$ $V_{GE} = 0V$	$T_j = 25^\circ C$	1.90	2.54	V
	chipelevel	$T_j = 150^\circ C$	2.08	2.60	V
V_{F0}	chipelevel	$T_j = 25^\circ C$	1.3	1.5	V
		$T_j = 150^\circ C$	0.9	1.1	V
r_F	chipelevel	$T_j = 25^\circ C$	18.0	20.0	m Ω
		$T_j = 150^\circ C$	25.0	28.0	m Ω
I_{RRM}	$I_F = 20A$	$T_j = 150^\circ C$	20		A
Q_{rr}	$di/dt_{off} = 1380A/\mu s$ $V_{GE} = \pm 15V$	$T_j = 150^\circ C$	8.0		μC
E_{rr}	$V_{CC} = 600 V$	$T_j = 150^\circ C$	3.0		mJ
$R_{th(j-c)}$	per diode			0.88	K/W
Module					
L_{CE}				30	nH
$R_{CC+EE'}$	terminal-chip	$T_C = 25^\circ C$	0.65		m Ω
		$T_C = 125^\circ C$	1		m Ω
$R_{th(c-s)}$	per module		0.04	0.05	K/W
M_s	to heat sink M5		3	5	Nm
M_t		to terminals M5	2.5	5	Nm
					Nm
Weight				170	g

S4G40T120SC9

H bridge IGBT modules

Features

- Trench Field Stop technology
- Ultra fast free wheeling diodes technology
- Low switching losses
- Switching frequency up to 20KHz
- Positive temperature coefficient for easy paralleling
- MOS input, voltage controlled

Application

- AC and DC motor control
- AC servo and robot drives
- Power supplies
- Welding inverters

Advantages

- space and weight savings
- reduced protection circuits

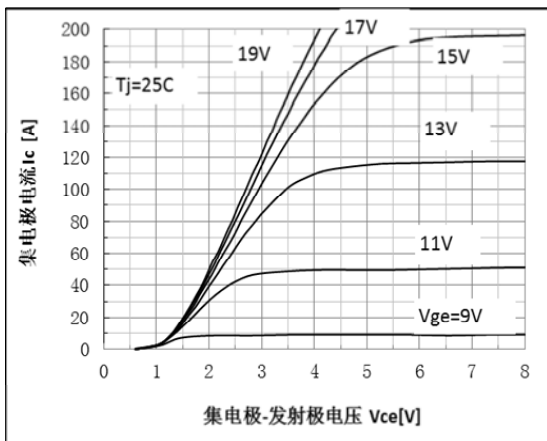


Fig.1 Output characteristic curve

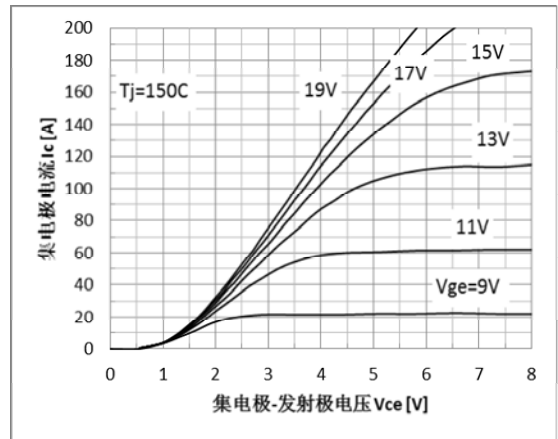


Fig. 2 Output characteristic curve

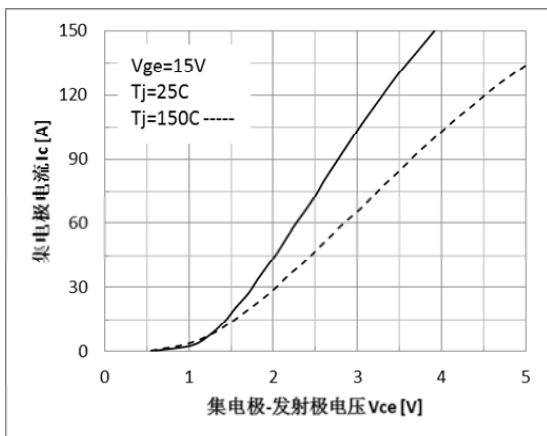


Fig.3 Saturation pressure drop characteristics

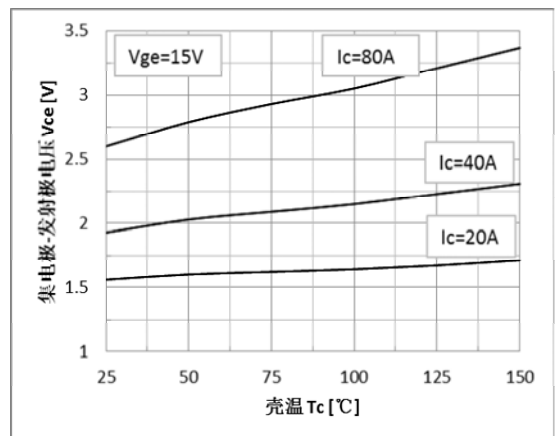


Fig.4 Saturation pressure drop temperature characteristics

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H bridge IGBT modules

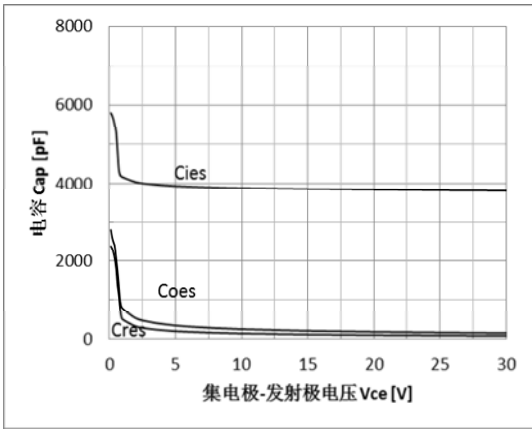


Fig.5 Capacitance characteristics

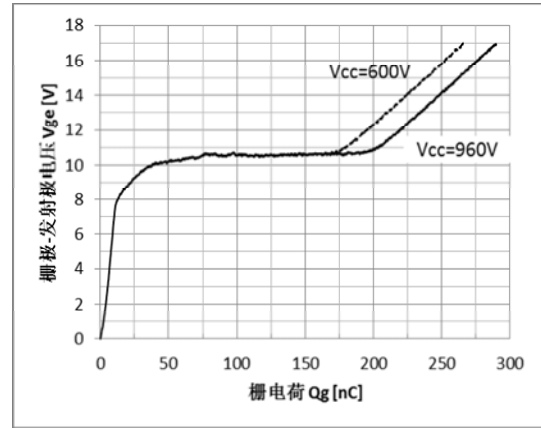


Fig.6 Gate charge characteristic

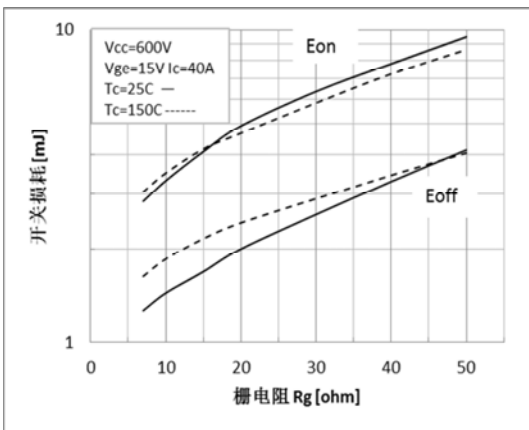


Fig.7 Switching loss - gate resistance characteristic curve

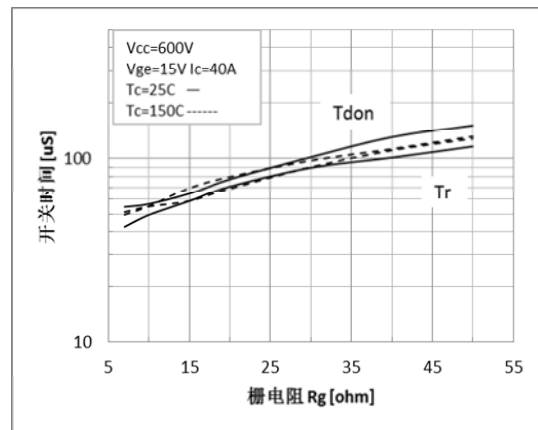


Fig.8 Turn-on - gate resistance characteristic curve

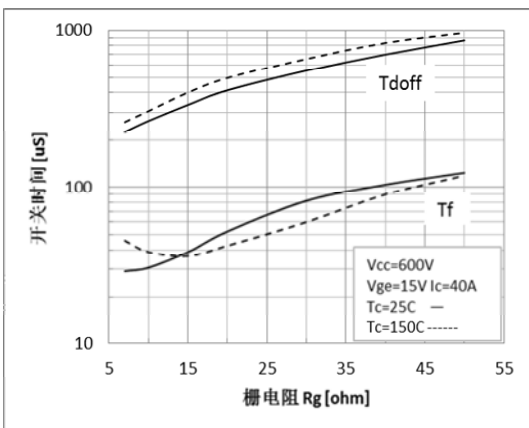


Fig.9 Turn-off - gate resistance characteristic curve

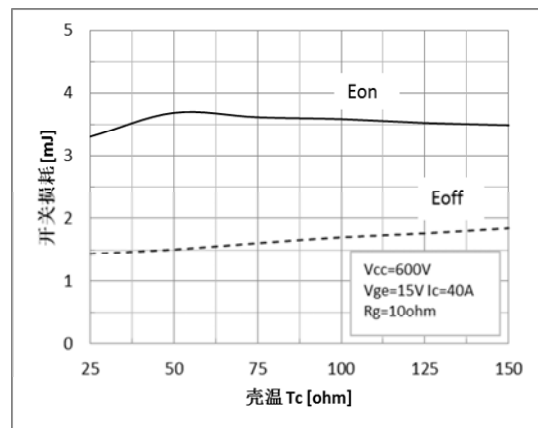


Fig.10 Temperature characteristics of switching losses

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H bridge IGBT modules

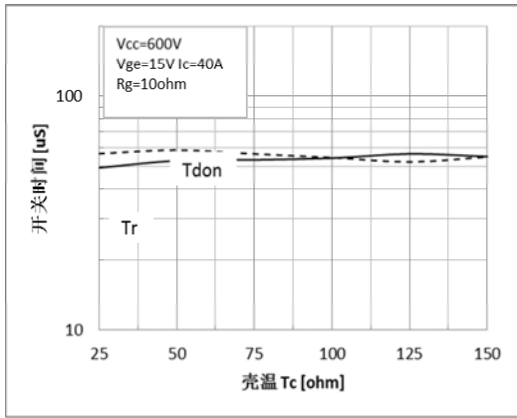


Fig.11 Turn-on temperature characteristics

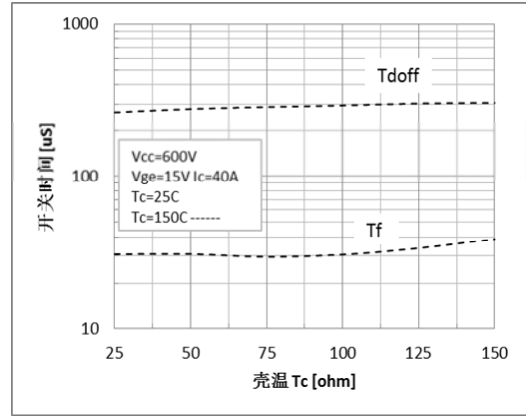


Fig.12 Turn-off temperature characteristics

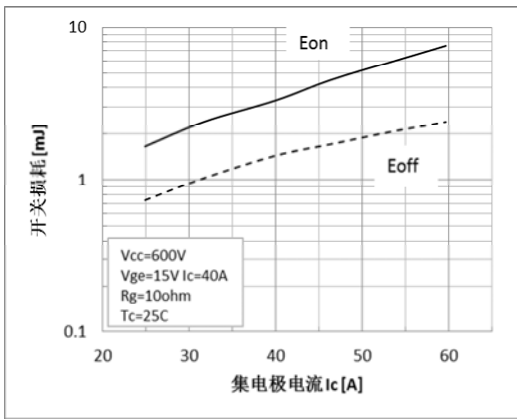


Fig.13 Switching loss and current characteristics

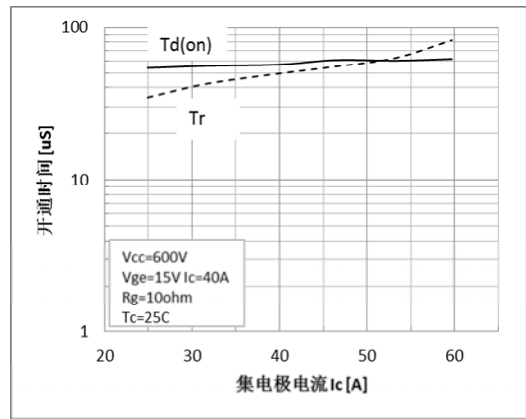


Fig.14 Turn-on and current characteristics

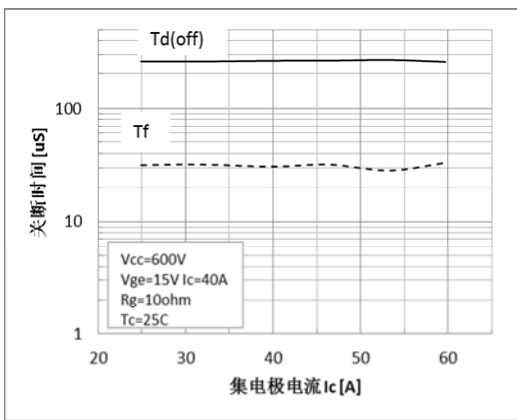


Fig.15 Turn-off and current characteristics

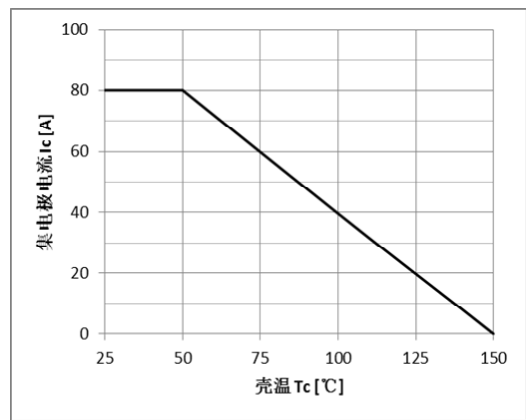


Fig.16 Collector current-temperature characteristics

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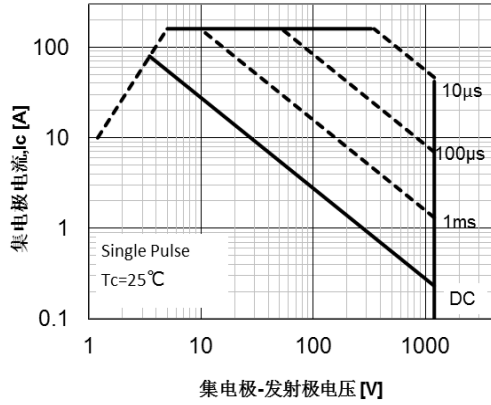


Fig.17 Forward Safe Workspac

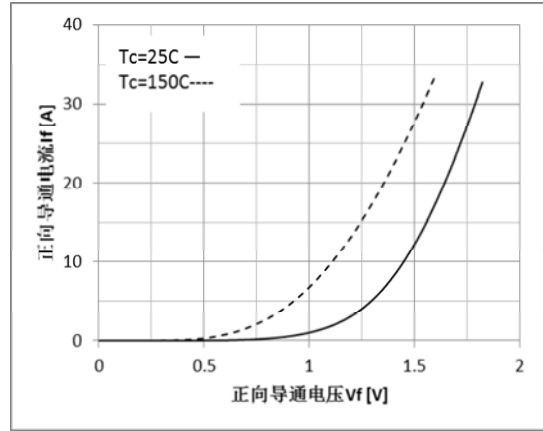


Fig.18 Forward characteristics of the diode

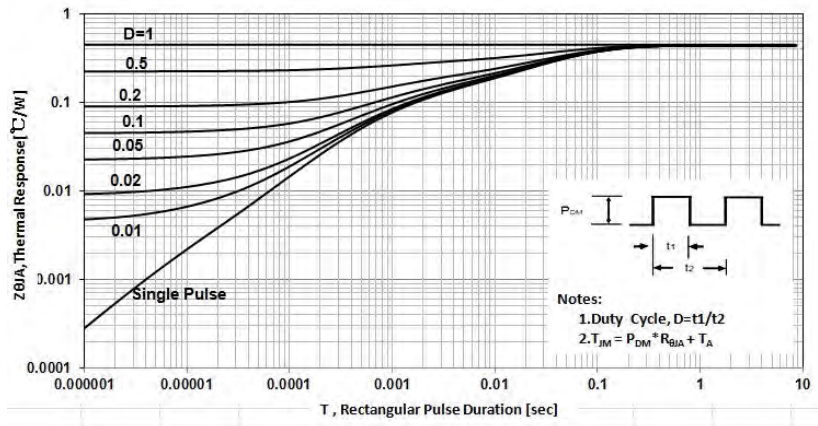


Fig.19 Transient thermal resistance characteristics